Rectifier diodes schottky barrier

BYV133 series

GENERAL DESCRIPTION

Dual, low leakage, platinum barrier, schottky rectifier diodes in a plastic envelope featuring low forward voltage drop and absence of stored charge. These devices can withstand reverse voltage transients and have guaranteed reverse surge capability. The devices are intended for use in switched mode power supplies and high frequency circuits in general where low conduction and zero switching losses are important.

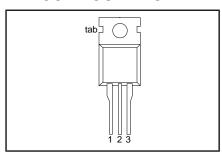
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V_{RRM}	BYV133- Repetitive peak reverse voltage	35 35	40 40	45 45	V
V _F I _{O(AV)}	Forward voltage Output current (both diodes conducting)	0.60 20	0.60 20	0.60 20	V A

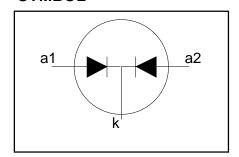
PINNING - TO220AB

PIN	DESCRIPTION	
1	anode 1 (a)	
2	cathode (k)	
3	anode 2 (a)	
tab	cathode (k)	

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT	
V _{RRM} V _{RWM} V _R	Repetitive peak reverse voltage Crest working reverse voltage Continuous reverse voltage	T _{mb} ≤ 145°C		-35 35 35 35	-40 40 40 40	-45 45 45 45	>>>
I _{O(AV)}	Output current (both diodes conducting) ¹	square wave; $\delta = 0.5$; $T_{mb} \le 122 ^{\circ}C$	-		20		A
		sinusoidal; a = 1.57; $T_{mb} \le 123 \degree C$	-		18		A
I _{O(RMS)}	RMS forward current		-		28		A
I _{FRM}	Repetitive peak forward current per diode	$t = 25 \mu s$; $δ = 0.5$; $T_{mb} \le 122 °C$	-		20		Α
I _{FSM}	Non-repetitive peak forward	t = 10 ms	-		100		A
	current per diode	t = 8.3 ms sinusoidal $T_i = 125 ^{\circ}\text{C}$ prior to surge; with reapplied $V_{\text{RWM}(\text{max})}$	-		110		A
l ² t	I ² t for fusing	t = 10 ms	-		50		A ² s
I _{RRM}	Repetitive peak reverse current per diode.	,	-		1		A
I _{RSM}	Non-repetitive peak reverse current per diode.	$t_p = 100 \ \mu s$	-		1		A
T_{stg}	Storage temperature		-65		175		°C
Tj	Operating junction temperature		-		150		°C

¹ For output currents in excess of 20A, connection should be made to the exposed metal mounting base.

Rectifier	diodes
schottky	barrier

BYV133 series

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{\text{th } j\text{-mb}}$ $R_{\text{th } j\text{-a}}$	mounting base	per diode both diodes in free air.		- - 60	2.6 1.6 -	K/W K/W K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage (per diode)	I _F = 7 A; T _j = 150°C I _E = 20 A	-	0.55	0.60	V
		$I_{\rm F} = 20 {\rm A}^{\circ}$	-	0.88	0.94	V
I _R	Reverse current (per diode)	$\dot{V}_R = V_{RWM}$	-	50	100	μΑ
		$V_{R} = V_{RWM}$; $T_{i} = 125 ^{\circ}C$	-	4	15	mΑ
C _d	Junction capacitance (per	$V_R = V_{RWM}^{RWW}$; T _j = 125 °C f = 1 MHz; V _R = 5 V; T _j = 25 °C to	-	300	-	pF
-	diode)	125 °C				

Rectifier diodes schottky barrier

BYV133 series

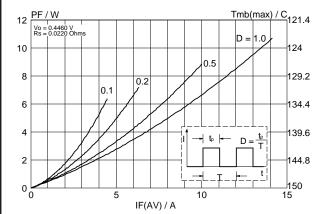
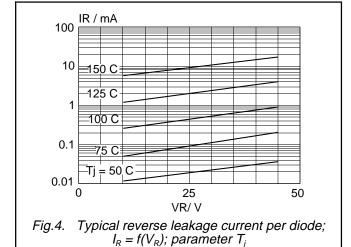


Fig.1. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; square current waveform where $I_{F(AV)} = I_{F(RMS)} \times \sqrt{D}$.



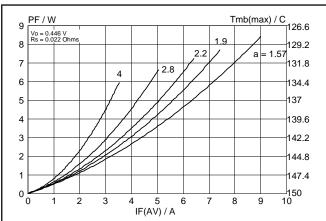


Fig.2. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; sinusoidal current waveform where a = form factor $= I_{F(RMS)} / I_{F(AV)}$.

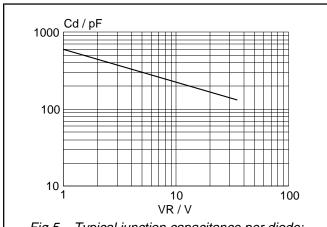


Fig.5. Typical junction capacitance per diode; $C_d = f(V_R)$; f = 1 MHz; $T_j = 25$ °C to 125 °C.

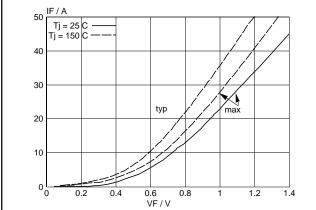


Fig.3. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_i

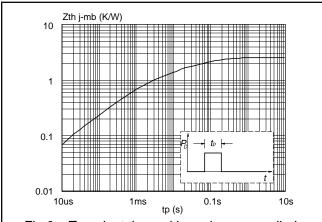
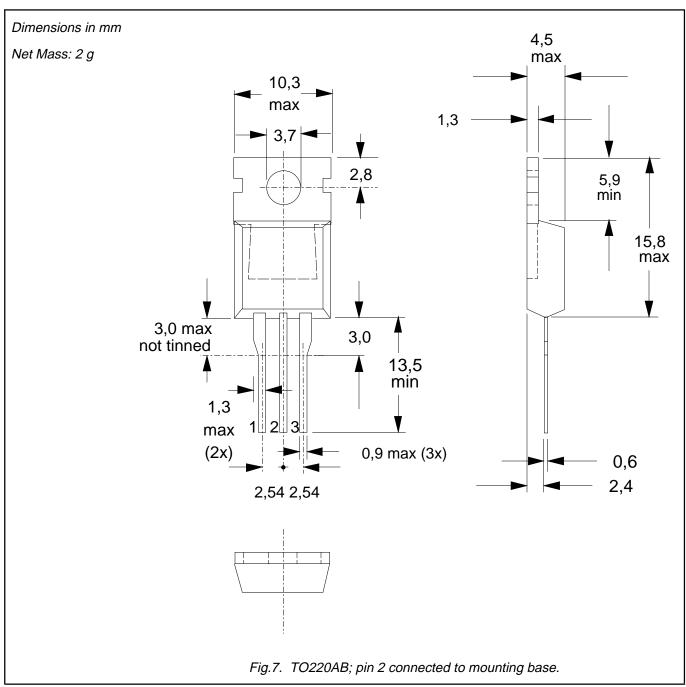


Fig.6. Transient thermal impedance; per diode; $Z_{th j-mb} = f(t_p)$.

BYV133 series

MECHANICAL DATA



- Accessories supplied on request: refer to mounting instructions for TO220 envelopes.
 Epoxy meets UL94 V0 at 1/8".

Rectifier	diodes
schottky	barrier

BYV133 series

DEFINITIONS

Data sheet status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Product specification	This data sheet contains final product specifications.				

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

© Philips Electronics N.V. 1994

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.